

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
PATENT APPLICATION**

Appl. No.:	10/695,026	Confirmation No.:	5704
Applicant:	Sunil Thomas		
Filed:	October 28, 2003		
TC/AU:	2813		
Examiner:	Jack S. J. Chen		
Docket:	TI-29525.1A		
Cust. No.:	23494		
Title:	Flip-Chip Assembly of Protected Micromechanical Devices		

Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

Supplement to Previous Amendments under 37 CFR § 1.111

Sir:

In response to the miscellaneous Office Action mailed June 6th, 2007 in connection with the above identified application, Applicant respectfully submits the following set of claims which includes withdrawn claims (36-44).

Amendments to the Claims begin on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.